

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Michael Bauer et al. Examiner: Julia Slutsker  
Serial No.: 10/565,259 Group Art Unit: 2891  
Filed: January 19, 2006 Docket No.: I431.45.101/FIN606PCT/US  
Title: SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR  
POPULATING SUBSTRATES WITH SOLDER BALLS

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**AMENDMENT AND RESPONSE**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This Amendment and Response is in reply to the Non-Final Office Action mailed August 12, 2009. Please amend the above-identified patent application as follows: